

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX541F, TC74LCX541FK

Low-Voltage Octal Bus Buffer with 5-V Tolerant Inputs and Outputs

The TC74LCX541 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

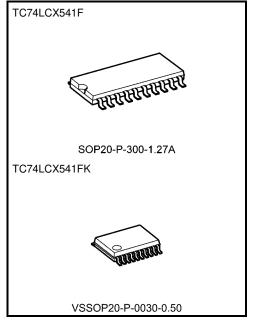
The device is designed for low-voltage $(3.3\ V)\ V_{CC}$ applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX541 is a non-inverting 3-state buffer having two active-low output enables. When either $\overline{\text{OE}1}$ or $\overline{\text{OE}2}$ are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Available in JEITA SOP, VSSOP (US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 541 type



Weight:

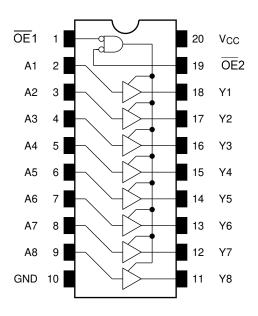
SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Note: The Electrical Characteristics of V_{CC} = 1.8 \pm 0.15 V is only applicable for products which manufactured from January 2009 onward.

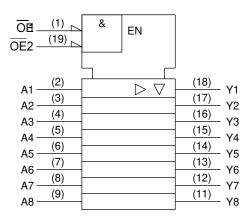
Start of commercial production 1995-02



Pin Assignment (top view)



IEC Logic Symbol



Truth Table

	Outputo		
ŌE1	OE2	An	Outputs
Н	Х	Х	Z
Х	Н	Х	Z
L	L	Н	Н
L	L	L	L

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lik	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Dower oupply voltage	Vac	1.65 to 3.6	V	
Power supply voltage	Vcc	1.5 to 3.6 (Note 2)		
Input voltage	VIN	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 3)	- V	
Output voltage	VOUT	0 to Vcc (Note 4)		
Output current	IOH/IOL	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	ША	
Operating temperature	Topr	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V



Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteristics Symbol Test Condition						Min N	May	Unit
Characteris	lics	Symbol	rest Condition		Vcc (V)	IVIII	Max	UIIIL
					1.65 to 2.3	Vcc×0.9	_	
	H-level	VIH	_	_		1.7	_	
land to alterna					2.7 to 3.6	2.0	_	V
Input voltage					1.65 to 2.3	_	Vcc×0.1	
	L-level	VIL	_		2.3 to 2.7	_	0.7	
					2.7 to 3.6	_	0.8	
				IOH = -100 μA	1.65 to 3.6	Vcc-0.2	_	
				I _{OH} = -4 mA	1.65	1.05	_	
	11111		W W STA	IOH = -8 mA	2.3	1.7		v
	H-level	Voн	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -12 mA	2.7	2.2		
				IOH = -18 mA	3.0	2.4	_	
Outrout walters				I _{OH} = -24 mA	3.0	2.2		
Output voltage			V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.65 to 3.6	_	0.2	
				I _{OL} = 4 mA	1.65	_	0.45	
	I. Invest			IOL = 8 mA	2.3		0.7	
	L-level	level V _{OL}		I _{OL} = 12 mA	2.7		0.4	
				IOL = 16 mA	3.0		0.4	
				I _{OL} = 24 mA	3.0		0.55	
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА
3-state output off-state current IoZ		V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА	
Power off leakage current IOFF VIN/VOUT = 5.5 V			0	_	10.0	μА		
O de constante de la constante		la a	V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0	
Quiescent supply curr	ent	Icc	V _{IN} /V _{OUT} = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	μА
Increase in ICC per inp	out	Δlcc	VIH = VCC - 0.6 V ((per 1 input)	2.7 to 3.6	_	500	



AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
			1.8 ± 0.15	_	25.0	
Drang gation delay times	tpLH	Figure 4 Figure 0	2.5 ± 0.2	_	8.5	
Propagation delay time	tpHL	Figure 1, Figure 2	2.7	_	7.5	ns
			3.3 ± 0.3	1.5	6.5	
		Figure 1, Figure 3	1.8 ± 0.15	_	34.0	- ns
Output anable time	^t pZL ^t pZH		2.5 ± 0.2	_	17.0	
Output enable time			2.7		9.5	
			3.3 ± 0.3	1.5	8.5	
	tpLZ tpHZ	Figure 1, Figure 3	1.8 ± 0.15	_	32.0	
Outrout disable times			2.5 ± 0.2	_	16.0	
Output disable time			2.7	_	8.5	ns
			3.3 ± 0.3	1.5	7.5	
Output to output alcour	tosLH	(1)	2.7	_	_	20
Output to output skew	tosHL	(Note)	3.3 ± 0.3	_	1.0	ns

Note: Parameter guaranteed by design.

 $(tosLH = |tpLHm - tpLHn|, \, tosHL = |tpHLm - tpHLn|)$

Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	CIN	_	3.3	7	pF
Output capacitance	Соит	_	3.3	8	pF
Power dissipation capacitance	CPD	f _{IN} = 10 MHz (No	e) 3.3	40	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

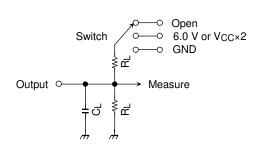
Average operating current can be obtained by the equation:

ICC (opr) = CPD \cdot VCC \cdot fIN + ICC/8 (per bit)

2021-03-26



AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
+ 1 7 + 71	6.0 V @ V _{CC} =3.3±0.3 @ V _{CC} =2.7V		
tpLZ, tpZL	V _{CC} ×2 @ V _{CC} =2.5±0.2\ @ V _{CC} =1.8±0.15		
t _{pHZ} , t _{pZH}	GND		

Figure 1



AC Waveform

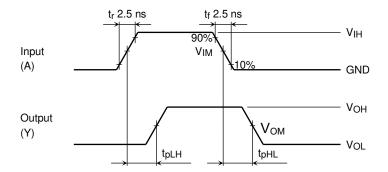


Figure 2 t_{pLH}, t_{pHL}

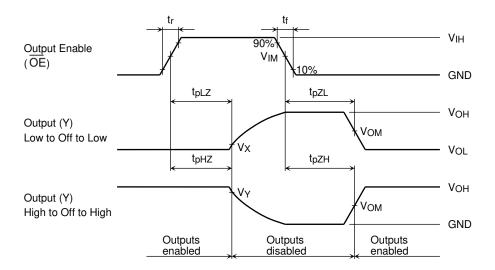


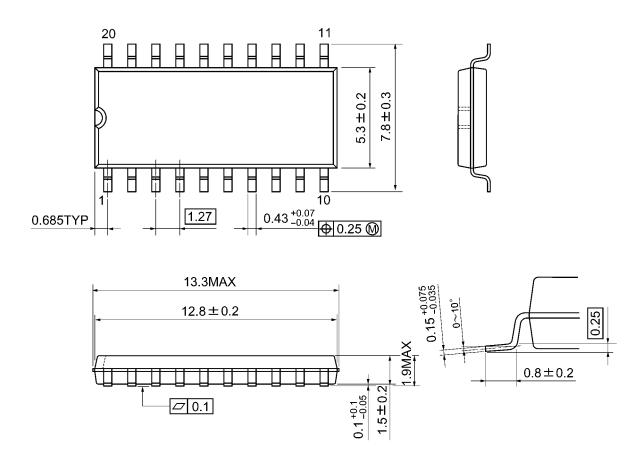
Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

		Vcc				
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V		
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}		
	V _{IM}	1.5 V	V _{CC} /2	V _{CC} /2		
	tr,tf	2.5 ns	2.0 ns	2.0 ns		
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2		
	VX	V _{OL} +0.3 V	V _{OL} +0.15 V	V _{OL} +0.15 V		
	VY	V _{OH} -0.3 V	V _{OH} -0.15 V	V _{OH} -0.15 V		
Load	CL	50 pF	30 pF	30 pF		
	RL	500 Ω	500 Ω	1 kΩ		



Package Dimensions

SOP20-P-300-1.27A Unit: mm

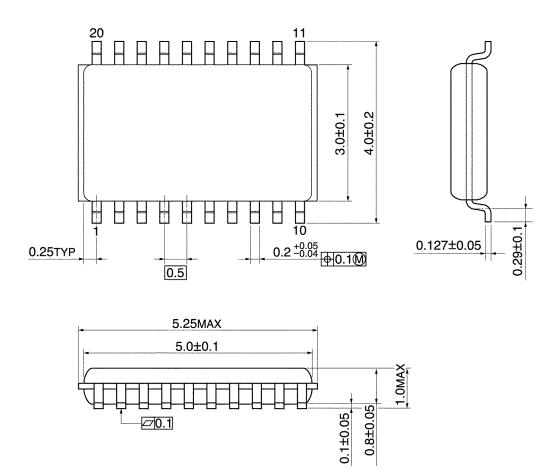


Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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